2SD2345

Silicon NPN epitaxial planer type

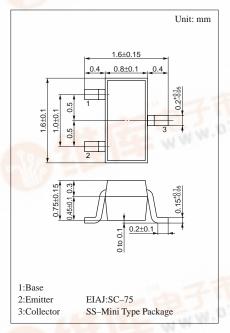
For low-frequency amplification

Features

- High foward current transfer ratio h_{FE}.
- Low collector to emitter saturation voltage V_{CE(sat)}.
- High emitter to base voltage V_{EBO}.
- Low noise voltage NV.

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	50	V
Collector to emitter voltage	V_{CEO}	40	V
Emitter to base voltage	V_{EBO}	15	V
Peak collector current	I_{CP}	100	mA
Collector current	I_{C}	50	mA
Collector power dissipation	P_{C}	125	mW
Junction temperature	T_{j}	125	°C
Storage temperature	T_{stg}	−55 ~ +125	°C
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- 1.70			



Marking symbol: 1Z

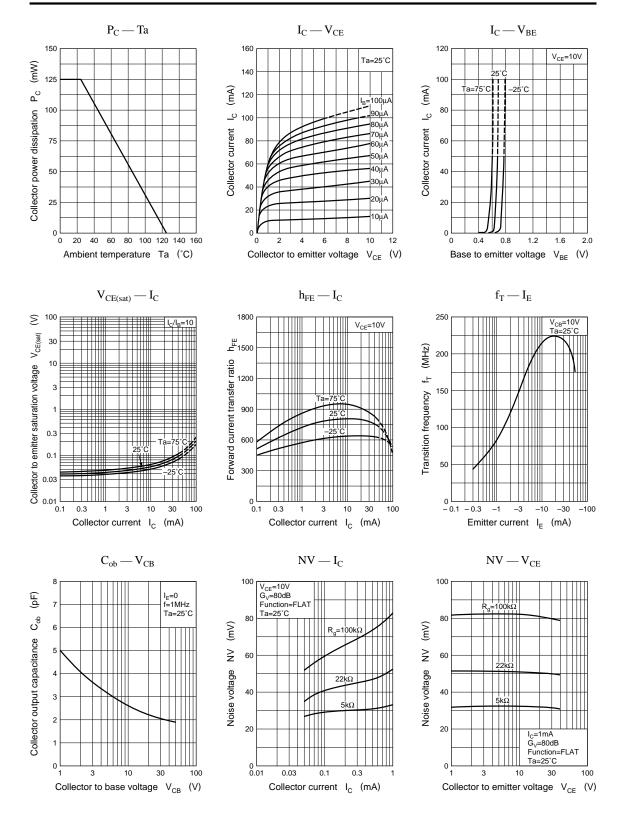
Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = 20V, I_E = 0$			100	nA
	I_{CEO}	$V_{CE} = 20V, I_{B} = 0$			1	μА
Collector to base voltage	V_{CBO}	$I_C = 10 \mu A, I_E = 0$	50			V
Collector to emitter voltage	V _{CEO}	$I_C = 1 \text{mA}, I_B = 0$	40		- 4	V
Emitter to base voltage	V_{EBO}	$I_{\rm E} = 10 \mu A, I_{\rm C} = 0$	15			V
Forward current transfer ratio	h _{FE} *	$V_{CE} = 10V, I_C = 2mA$	400		2000	
Collector to emitter saturation voltage	V _{CE(sat)}	$I_C = 10$ mA, $I_B = 1$ mA		0.05	0.2	V
Transition frequency	f_{T}	$V_{CB} = 10V, I_E = -2mA, f = 200MHz$		120		MHz

*h_{FE} Rank classification

Rank	R	S	T
h _{FE}	400 ~ 800	600 ~ 1200	1000 ~ 2000
13.0			

Transistor 2SD2345



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